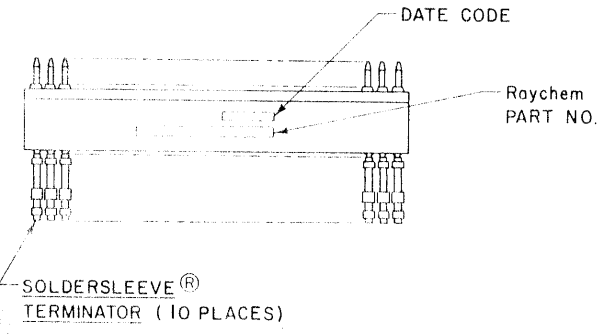
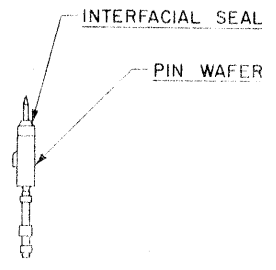
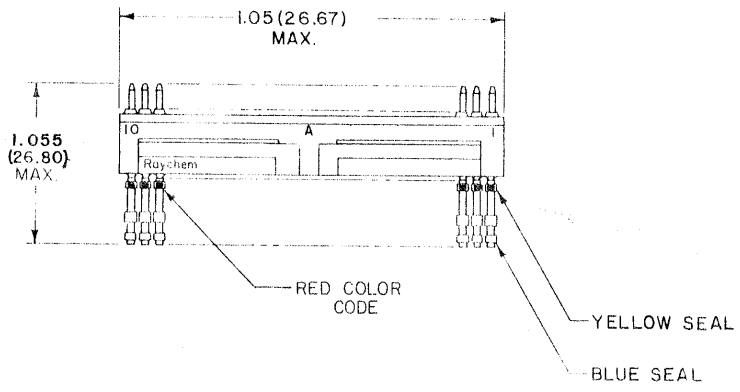
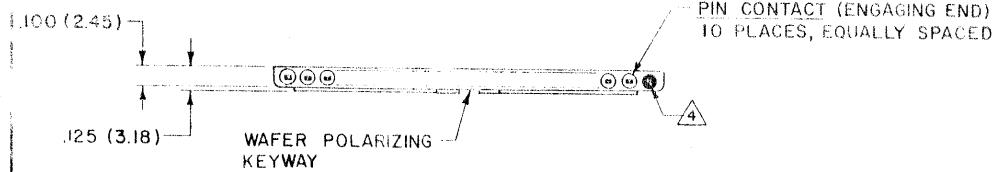




REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
2	REVISED PER ECN # T- 5866	4/1/83	[Signature]
1	RELEASED FOR PRODUCTION PER ECN T-512433	3/1/83	[Signature]

5 WEIGHT (MAX.): LBS. GRAMS
.0047 2.12

4 PIN NUMBER ONE IS MARKED IN CONTRASTING COLOR ON INTERFACIAL SEAL.

3. FINISH:
- 3-A PIN WAFER; FINISH TO BE AS MOLDED.
 - 3-B PIN CONTACT; GOLD PLATE PER MIL-G-45204, CLASS I.
 - 3-C CONTACT TAIL; COATED WITH Sn63 SOLDER PER QQ-S-571
2. MATERIAL:
- 2-A PIN WAFER; HIGH GRADE POLYARYLENE THERMOPLASTIC.
 - 2-B PIN CONTACT; COPPER ALLOY PER QQ-B-613 OR QQ-C-502
 - 2-C INTERFACIAL SEAL; SILICONE ELASTOMER PER MIL-R-25988
 - 2-D SOLDERSLLEEVE® TERMINATOR; REFER TO RAYCHEM DWG. CTA-0068 FOR DATA.

1. THIS WAFER ASSEMBLY USED IN MTC100 CONNECTORS.

NOTES:

If this document is printed it becomes uncontrolled.
Check with the web for latest revision.

SPECIFICATION CONTROL DRAWING

DRAWN	HAWKINGS	11-16-83	Raychem RAYCHEM CORPORATION 5000 CUNNINGHAM DRIVE MENLO PARK, CALIFORNIA 94025	
CHECKED	[Signature]			
APPROVED	[Signature]	12-2-83	TITLE WAFER ASSEMBLY, PIN, "A" STYLE, 1", 10 CONTACTS, WITH OVAL ENTRY FOR 20-26 AWG. TEMP. RATING 125° C MTC100 SERIES	
APPROVED	[Signature]	12-2-83		
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES ±.005 METRIC DIMENSIONS ARE IN PARENTHESES (M.M.)			SIZE	CODE IDENT NO.
DO NOT SCALE THIS DRAWING			C	06090
			DWG NO.	MTC100-JA1-PI4
			WEIGHT	5
			SHEET	1 OF 1